As a below-named inventor, I hereby declare that:

is attached hereto.

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled WAFER CARRIER AND SEMICONDUCTOR APPARATUS FOR PROCESSING A SEMICONDUCTOR SUBSTRATE, the specification of which

	Application S	as erial Noas ded on	(if applicable)
	•		contents of the above-identified adment referred to above.
	wledge the duty to dis patentability as define		e all information known to me to
foreign application below any foreign	tion(s) for patent or ir	nventor's certificate liste atent or inventor's certif	United States Code, §119 of any d below and have also identified ficate having a filing date before
Prior Foreign Application(s)			Priority Claimed
(Number)	(Country)	(Date Filed)	Yes [] No []
application(s) application is the first paragrate to the Patent C 37 C.F.R. 1.50	listed below and, ins not disclosed in the praph of Title 35, Unite Office all information	ofar as the subject mattrior United States appliced States Code, §112, I a known to me to be mater teen the filing date of the	s Code, §120 of any United States for of each of the claims of this ation in the manner provided by acknowledge the duty to disclose rial to patentability as defined in prior application and the national
(Applio	cation Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Applie	cation Serial No.)	(Filing Date)	(Status)

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File No. A-64873/AJT/MSS

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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